

PACKAGING HOT MELT

SW5060

Application: For bonding purposes in packaging processes, e.g. for cartons, trays, and folding boxes, including printed and lacquered surfaces.

Characteristics: Very good adhesion, high heat resistance of the bond, resistance to oxidation, minimal odor and smoke. (Comparable to Technomelt Supra 100)

Specification:

Polymer basis	Polyolefin
Viscosity at 160°C (mPa s)	1,500 - 2,500
Softening point	110 - 115°C
Setting time /25°C	< 5 sec
Supply form	White, translucent melt in granules
Application temperature	150 - 170°C

Packaging & Storage: in 25 kg kraft bag. 40 bags/ pallet
Shelf life of 24 months, in original package, cool and dry (15-35°C).

Remarks: All data indicated are characteristics represented as average values. Our technical data sheets are revised to represent the latest information. This edition is valid on the date of compilation.

TIANJIN SHENG-WANG ELECTRONIC
CHEMICAL PLANT

E-mail: sales@swadhesive.com
www.swhotmeltglue.com

FREE BIRD ®
Adhesives